Hewlett Packard



Project Size

20,160 sq ft

Construction

IBC Type V Protected

Contract Type

Design-build Stipulated sum

Facility Use

Office / Technology Center

Description

Wood and steel framework

Simulated stucco exterior Seismic foundation design

Completion

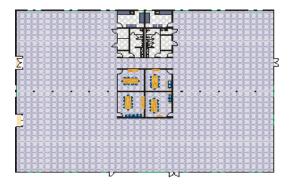
110 days

Traditional Modular Construction









To support a rapid expansion program Hewlett Packard turned to Ramtech for construction of this 20,160 square foot office / research center for the support of new integrated circuit technology. The Type V wood structure was designed, manufactured and erected in 110 days.

